

C0603X101J5GAC3190

SMD Auto COG Flex, Ceramic, 100 pF, 5%, 50 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade, 0603



Click here for the 3D model.

Dimensions	
Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.15mm
S	0.58mm MIN
В	0.45mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, 2mm Pitch, Paper Tape
Packaging Quantity	8000

SMD Auto COG Flex SMD Chip
014D 141 00 FT 04D 111 0: 11 4 : .:
SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade
FT-CAP, Ultra-Stable, Automotive Grade
Yes
Flexible Termination
No
AEC-Q200
Yes
4.6 mg
78 Weeks
1

Specifications	,
Capacitance	100 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.